onsemi

MOSFET – Power, Single N-Channel, DFN5/DFNW5

60 V, 71 A, 6.1 m Ω

NVMFS5C670NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C670NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Symbol	Parar	Value	Unit		
V _{DSS}	Drain-to-Source Voltag	60	V		
V _{GS}	Gate-to-Source Voltage	Э		±20	V
Ι _D	Continuous Drain			71	А
	Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C	50	
PD	Power Dissipation	State	T _C = 25°C	61	W
	R _{θJC} (Note 1)		$T_{\rm C} = 100^{\circ}{\rm C}$	31	
Ι _D	Continuous Drain		T _A = 25°C	17	А
	Current R _{θJA} (Notes 1, 2, 3)	Steady	$T_A = 100^{\circ}C$	12	
PD	Power Dissipation			3.6	W
	$R_{\theta JA}$ (Notes 1 & 2)		T _A = 100°C	1.8	
I _{DM}	Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	440	А
T _J , T _{stg}	Operating Junction and	ēmperature	–55 to + 175	°C	
۱ _S	Source Current (Body D	68	А		
E _{AS}	Single Pulse Drain-to-S Energy (I _{L(pk)} = 3.6 A)	166	mJ		
ΤL	Lead Temperature for S (1/8" from case for 10 s)	260	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Symbol	Parameter		Unit
$R_{\theta JC}$	Junction-to-Case - Steady State	2.4	°C/W
$R_{\theta JA}$	Junction-to-Ambient - Steady State (Note 2)	41	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

 Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

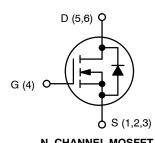
V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	6.1 mΩ @ 10 V	71 A
00 V	8.8 mΩ @ 4.5 V	





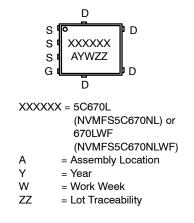
DFN5 (SO-8FL) CASE 488AA

DFNW5 CASE 507BE



N-CHANNEL MOSFET

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 5.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Test Condition		Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS	•					
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	V_{GS} = 0 V, I_{D} = 250 μ A		60			V
V _{(BR)DSS} / T _J	Drain-to-Source Breakdown Voltage Temperature Coefficient				27		mV/°C
I _{DSS}	$I_{DSS} \qquad \mbox{Zero Gate Voltage Drain Current} \qquad \mbox{V}_{GS} = 0 \ \mbox{V}, \\ \mbox{V}_{DS} = 60 \ \mbox{V}$	T _J = 25 °C		10			
V _{DS} = 6	$V_{\rm DS} = 60 V$	T _J = 125°C			250	μΑ	
I _{GSS}	Gate-to-Source Leakage Current	$V_{DS} = 0 V, V_{GS} = 20 V$				100	nA
ON CHARA	CTERISTICS (Note 4)						
V _{GS(TH)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 53 \ \mu A$		1.2		2.0	V
$V_{GS(TH)}/T_J$	Threshold Temperature Coefficient				-4.7		mV/°C
R _{DS(on)}	Drain-to-Source On Resistance	V _{GS} = 10 V	I _D = 35 A		5.1	6.1	
		V _{GS} = 4.5 V	I _D = 35 A		7.0	8.8	mΩ

CHARGES AND CAPACITANCES

g_{FS}

Forward Transconductance

C _{ISS}	Input Capacitance		140	00	
C _{OSS}	Output Capacitance	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V	69	0	pF
C _{RSS}	Reverse Transfer Capacitance		1:	5	
Q _{G(TOT)}	Total Gate Charge	V_{GS} = 4.5 V, V_{DS} = 48 V; I_{D} = 35 A	9.	D	nC
Q _{G(TOT)}	Total Gate Charge	V_{GS} = 10 V, V_{DS} = 48 V; I_{D} = 35 A	20)	nC
Q _{G(TH)}	Threshold Gate Charge		2.	5	
Q _{GS}	Gate-to-Source Charge		4.	5	nC
Q _{GD}	Gate-to-Drain Charge	V _{GS} = 10 V, V _{DS} = 48 V; I _D = 35 A	2.	D	
V _{GP}	Plateau Voltage		3.	1	V

 $V_{DS} = 15 \text{ V}, \text{ I}_{D} = 35 \text{ A}$

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SWITCHING CHARACTERISTICS (Note 5)

t _{d(ON)}	Turn-On Delay Time		11	
t _r	Rise Time	V _{GS} = 4.5 V, V _{DS} = 48 V,	60	20
t _{d(OFF)}	Turn-Off Delay Time	$I_{\rm D} = 35 \text{ A}, \text{ R}_{\rm G} = 2.5 \Omega$	15	ns
t _f	Fall Time		4	

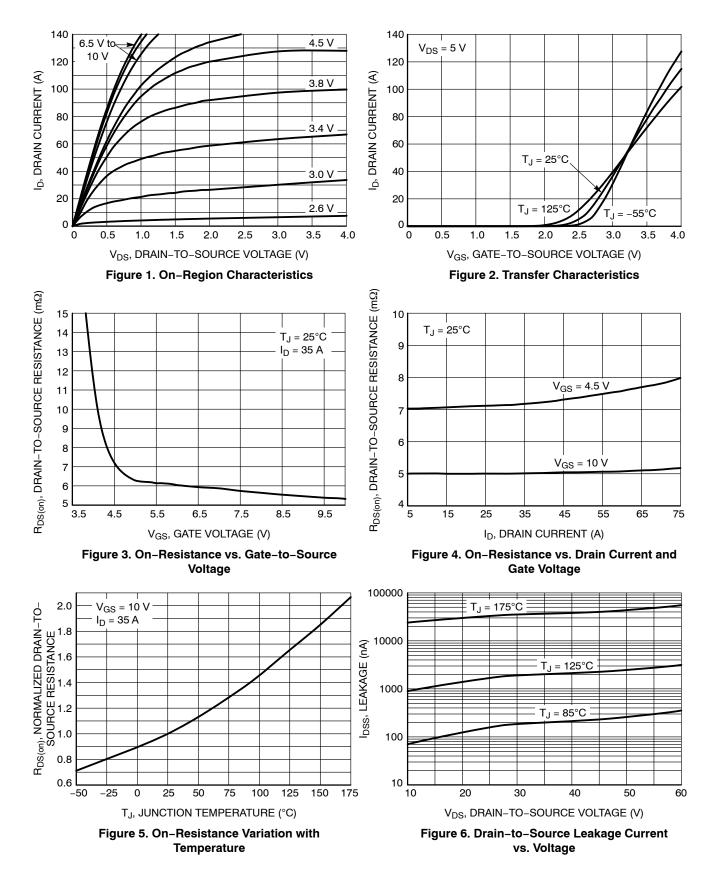
DRAIN-SOURCE DIODE CHARACTERISTICS

V _{SD}	Forward Diode Voltage	V _{GS} = 0 V, I _S = 35 A	$T_J = 25^{\circ}C$	0.9	1.2	V
		I _S = 35 A	I _S = 35 A T _J = 125°C	0.8		v
t _{RR}	Reverse Recovery Time	V _{GS} = 0 V, dI _S /d _t = 100 A/µs, I _S = 35 A		34		
t _a	Charge Time			17		ns
t _b	Discharge Time			17		
Q _{RR}	Reverse Recovery Charge			19		nC

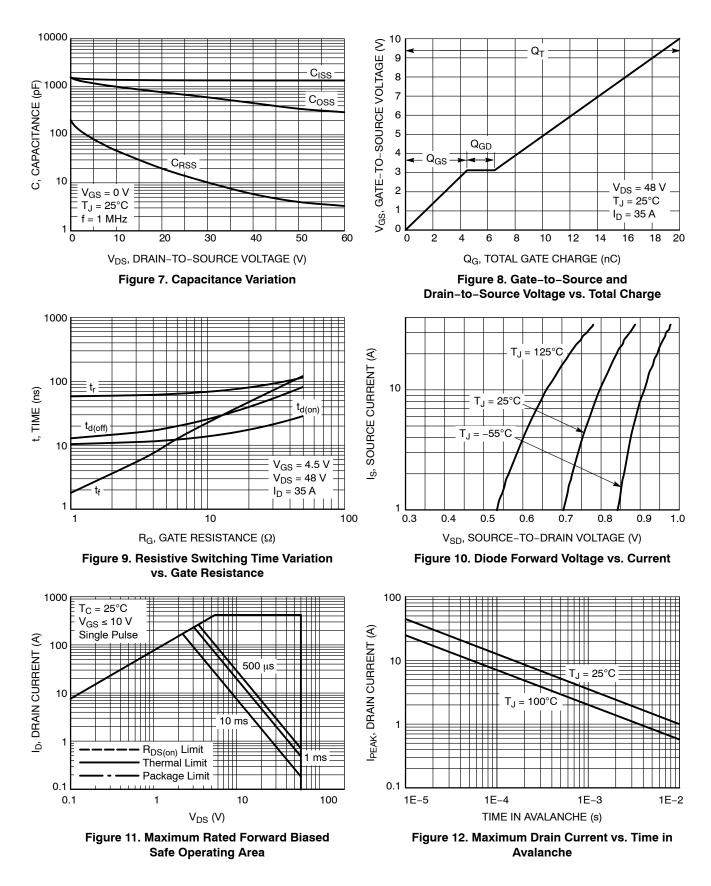
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

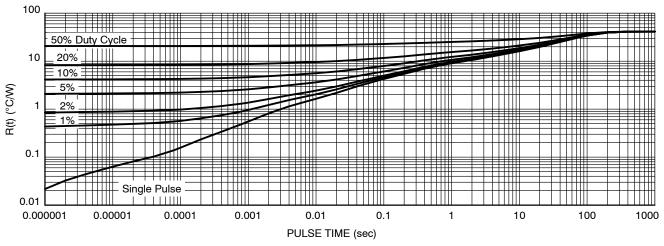


Figure 13. Thermal Characteristics

Device	Marking	Package	Shipping [†]
NVMFS5C670NLT1G	5C670L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C670NLAFT1G	5C670L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C670NLAFT1G-YE	5C670L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C670NLWFAFT1G	670LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C670NLWFAFT3G	670LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel

DEVICE ORDERING INFORMATION

DISCONTINUED (Note 6)

NVMFS5C670NLWFT3G	670LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel
NVMFS5C670NLWFT1G	670LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C670NLT3G	5C670L	DFN5 (Pb–Free)	5000 / Tape & Reel

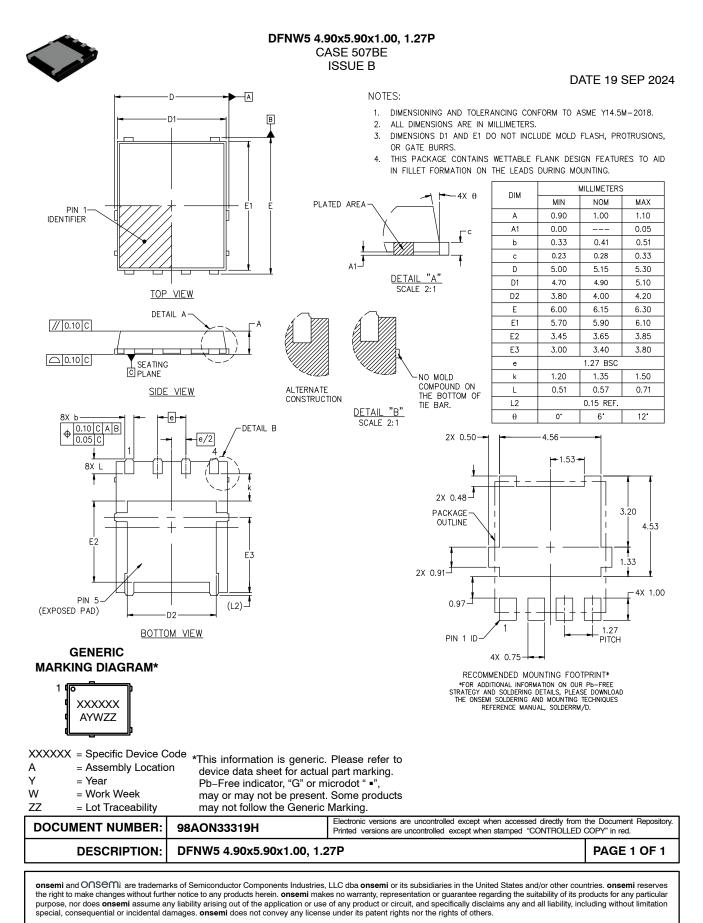
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

6. **DISCONTINUED:** This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on <u>www.onsemi.com</u>.

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